

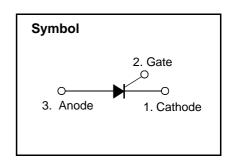
# Sensitive Gate Silicon Controlled Rectifiers

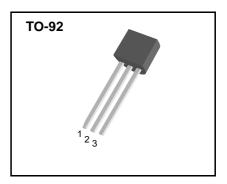
#### **Features**

- 4U.COIII
  - ◆ Repetitive Peak Off-State Voltage : 600V
  - ullet R.M.S On-State Current (  $I_{T(RMS)}$ = 0.6 A )
  - ♦ Low On-State Voltage (1.2V(Typ.)@ I<sub>TM</sub>)

### **General Description**

Sensitive triggering SCR is suitable for the application where gate current limited such as small motor control, gate driver for large SCR, sensing and detecting circuits.





### **Absolute Maximum Ratings** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter Condition		Ratings	Units
V <sub>DRM</sub>	Repetitive Peak Off-State Voltage		600	V
I <sub>T(AV)</sub>	Average On-State Current	Half Sine Wave : T <sub>C</sub> = 74 °C	0.5	Α
I <sub>T(RMS)</sub>	R.M.S On-State Current	All Conduction Angle	0.6	А
I <sub>TSM</sub>	Surge On-State Current	1/2 Cycle, 60Hz, Sine Wave Non-Repetitive	6	А
l <sup>2</sup> t	I <sup>2</sup> t for Fusing	t = 8.3ms	0.415	A <sup>2</sup> s
P <sub>GM</sub>	Forward Peak Gate Power Dissipation	Ta =25°C, Pulse Width $\leq 1.0 \mu s$	2	W
P <sub>G(AV)</sub>	Forward Average Gate Power Dissipation	T <sub>A</sub> =25°C, t = 8.3ms	0.1	W
I <sub>FGM</sub>	Forward Peak Gate Current		1	Α
$V_{RGM}$	Reverse Peak Gate Voltage		5.0	V
T <sub>J</sub>	Operating Junction Temperature		- 40 ~ 125	°C
T <sub>STG</sub>	Storage Temperature		- 40 ~ 150	°C[P



1/5

## PCR606J

### **Electrical Characteristics** ( $T_C = 25 \, ^{\circ}\text{C}$ unless otherwise noted )

	Items	One distant	Ratings			11.24
Symbol		Conditions	Min.	Тур.	Max.	Unit
U.com I <sub>DRM</sub>	Repetitive Peak Off-State Current	$V_{AK} = V_{DRM}$ or $V_{RRM}$ ; $R_{GK} = 1000 \Omega$ $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 125 ^{\circ}\text{C}$			10 200	μA
V <sub>TM</sub>	Peak On-State Voltage (1)	(I <sub>TM</sub> = 1 A, Peak)	_	1.2	1.7	V
I <sub>GT</sub>	Gate Trigger Current (2)	$V_{AK}$ = 6 V, $R_L$ =100 $\Omega$ $T_C = 25  ^{\circ}C$ $T_C = -40  ^{\circ}C$	_	_	200 500	μA
V <sub>GT</sub>	Gate Trigger Voltage (2)	$V_D$ = 7 V, $R_L$ =100 $\Omega$ $T_C$ = 25 °C $T_C$ = -40 °C	_	_	0.8 1.2	V
V <sub>GD</sub>	Non-Trigger Gate Voltage (1)	$V_{AK} = 12 \text{ V}, R_L = 100 \Omega$ $T_C = 125 \text{ °C}$	0.2	_	_	V
dv/dt	Critical Rate of Rise Off-State Voltage	$V_D$ = 0.67 $V_{DRM}$ , Exponential waveform, $R_{GK}$ = $1000 \Omega$ $T_J$ =125°C	500	800	_	V/μs
di/dt	Critical Rate of Rise On-State Current	I <sub>TM</sub> = 2A ; I <sub>g</sub> = 10mA	_	_	50	A/μs
IH	Holding Current	$V_{AK}$ = 12 V, Gate Open Initiating Curent = 50mA $T_{C}$ = 25 °C $T_{C}$ = -40 °C	_ _	2 —	5.0 10	mA
R <sub>th(j-c)</sub>	Thermal Impedance	Junction to case	_	_	60	°C/W
R <sub>th(j-a)</sub>	Thermal Impedance	Junction to Ambient	_	_	150	°C/W

### \* Notes:

- 1. Pulse Width  $\,\leq\,$  1.0 ms , Duty cycle  $\,\leq\,$  1%
- 2. Does not include  $R_{\mbox{\scriptsize GK}}\,$  in measurement.

K

Fig 1. Gate Characteristics

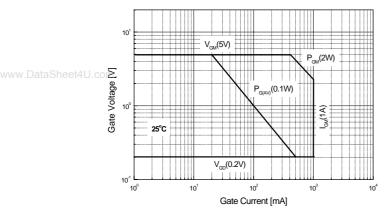


Fig 3. Typical Forward Voltage

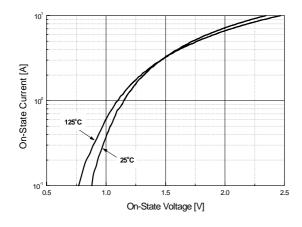


Fig 5. Typical Gate Trigger Voltage vs. Junction Temperature

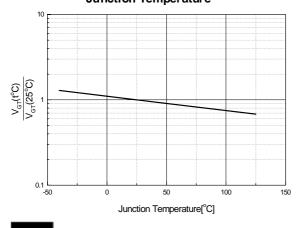


Fig 2. Maximum Case Temperature

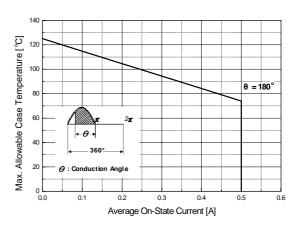


Fig 4. Thermal Response

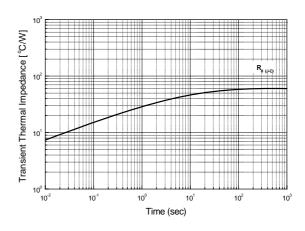
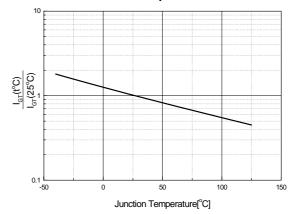


Fig 6. Typical Gate Trigger Current vs. Junction Temperature



Wed: http://www.kcd.net.cn

3/5

Email:kcd@kcd.net.cn

Fig 7. Typical Holding Current

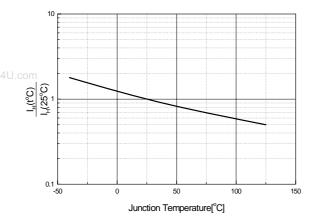
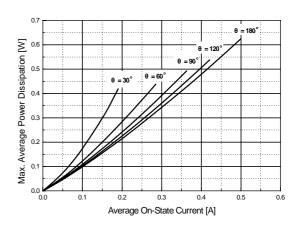


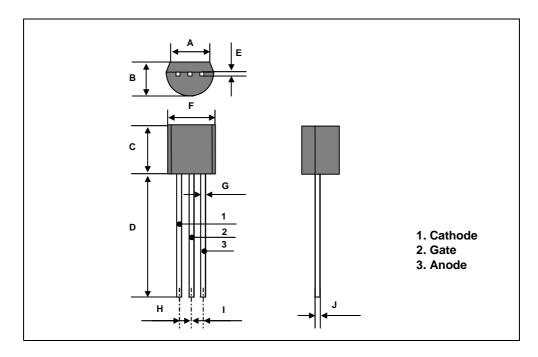
Fig 8. Power Dissipation



### **TO-92 Package Dimension**

ww.DataSheet4U.com

Dim.	mm			Inch			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А		4.2			0.165		
В			3.7			0.146	
С	4.43		4.83	0.174		0.190	
D	14.07		14.87	0.554		0.585	
E			0.4			0.016	
F	4.43		4.83	0.174		0.190	
G			0.45			0.017	
Н		2.54			0.100		
I		2.54			0.100		
J	0.33		0.48	0.013		0.019	



K

5/5